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### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	30 MIPS
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	20
Program Memory Size	12KB (4K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 10x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/dspic30f2012t-30i-so">https://www.e-xfl.com/product-detail/microchip-technology/dspic30f2012t-30i-so</a>

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NOTES:

## 5.6 Programming Operations

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. A programming operation is nominally 2 msec in duration and the processor stalls (waits) until the operation is finished. Setting the WR bit (NVMCON<15>) starts the operation and the WR bit is automatically cleared when the operation is finished.

### 5.6.1 PROGRAMMING ALGORITHM FOR PROGRAM FLASH

The user can erase or program one row of program Flash memory at a time. The general process is:

1. Read one row of program Flash (32 instruction words) and store into data RAM as a data "image".
2. Update the data image with the desired new data.
3. Erase program Flash row.
  - a) Set up NVMCON register for multi-word, program Flash, erase, and set WREN bit.
  - b) Write address of row to be erased into NVMADRU/NVMADR.
  - c) Write 0x55 to NVMKEY.
  - d) Write 0xAA to NVMKEY.
  - e) Set the WR bit. This begins erase cycle.
  - f) CPU stalls for the duration of the erase cycle.
  - g) The WR bit is cleared when erase cycle ends.

4. Write 32 instruction words of data from data RAM "image" into the program Flash write latches.
5. Program 32 instruction words into program Flash.
  - a) Set up NVMCON register for multi-word, program Flash, program, and set WREN bit.
  - b) Write 0x55 to NVMKEY.
  - c) Write 0xAA to NVMKEY.
  - d) Set the WR bit. This begins program cycle.
  - e) CPU stalls for duration of the program cycle.
  - f) The WR bit is cleared by the hardware when program cycle ends.
6. Repeat steps 1 through 5 as needed to program desired amount of program Flash memory.

### 5.6.2 ERASING A ROW OF PROGRAM MEMORY

**Example 5-1** shows a code sequence that can be used to erase a row (32 instructions) of program memory.

#### EXAMPLE 5-1: ERASING A ROW OF PROGRAM MEMORY

```

; Setup NVMCON for erase operation, multi word write
; program memory selected, and writes enabled
    MOV    #0x4041,W0
    MOV    W0,NVMCON
; Init pointer to row to be ERASED
    MOV    #tblpage(PROG_ADDR),W0
    MOV    W0,NVMADRU
    MOV    #tbloffset(PROG_ADDR),W0
    MOV    W0,NVMADR
    DISI    #5
; Block all interrupts with priority <7 for
; next 5 instructions

    MOV    #0x55,W0
    MOV    W0,NVMKEY
    MOV    #0xAA,W1
    MOV    W1,NVMKEY
    BSET    NVMCON,#WR
    NOP
    NOP
; Write the 0x55 key
;
; Write the 0xAA key
; Start the erase sequence
; Insert two NOPs after the erase
; command is asserted
    
```

**TABLE 7-5: PORTD REGISTER MAP FOR dsPIC30F2012/3013**

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
TRISD	02D2	—	—	—	—	—	—	TRISD9	TRISD8	—	—	—	—	—	—	—	—	0000 0011 0000 0000
PORTD	02D4	—	—	—	—	—	—	RD9	RD8	—	—	—	—	—	—	—	—	0000 0000 0000 0000
LATD	02D6	—	—	—	—	—	—	LATD9	LATD8	—	—	—	—	—	—	—	—	0000 0000 0000 0000

**Legend:** — = unimplemented bit, read as '0'

**TABLE 7-6: PORTF REGISTER MAP FOR dsPIC30F2012/3013**

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
TRISF	02DE	—	—	—	—	—	—	—	—	—	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	—	—	0000 0000 0111 1100
PORTF	02E0	—	—	—	—	—	—	—	—	—	RF6	RF5	RF4	RF3	RF2	—	—	0000 0000 0000 0000
LATF	02E2	—	—	—	—	—	—	—	—	—	LATF6	LATF5	LATF4	LATF3	LATF2	—	—	0000 0000 0000 0000

**Legend:** — = unimplemented bit, read as '0'

**Note:** The dsPIC30F2011/3012 devices do not have TRISF, PORTF, or LATF.

**TABLE 8-2: dsPIC30F2011/2012/3012 INTERRUPT CONTROLLER REGISTER MAP**

SFR Name	ADR	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
INTCON1	0080	NSTDIS	—	—	—	—	OVATE	OVATE	COVTE	—	—	—	MATHERR	ADDRERR	STKERR	OSCFail	—	0000 0000 0000 0000
INTCON2	0082	ALTIVT	DISI	—	—	—	—	—	—	—	—	—	—	—	INT2EP	INT1EP	INT0EP	0000 0000 0000 0000
IFS0	0084	CNIF	MI2CIF	SI2CIF	NVMIF	ADIF	U1TXIF	U1RXIF	SPI1IF	T3IF	T2IF	OC2IF	IC2IF	T1IF	OC1IF	IC1IF	INT0IF	0000 0000 0000 0000
IFS1	0086	—	—	—	—	—	—	—	—	INT2IF	—	—	—	—	—	—	INT1IF	0000 0000 0000 0000
IFS2	0088	—	—	—	—	—	LVDIF	—	—	—	—	—	—	—	—	—	—	0000 0000 0000 0000
IEC0	008C	CNIE	MI2CIE	SI2CIE	NVMIE	ADIE	U1TXIE	U1RXIE	SPI1IE	T3IE	T2IE	OC2IE	IC2IE	T1IE	OC1IE	IC1IE	INT0IE	0000 0000 0000 0000
IEC1	008E	—	—	—	—	—	—	—	—	INT2IE	—	—	—	—	—	—	INT1IE	0000 0000 0000 0000
IEC2	0090	—	—	—	—	—	LVDIE	—	—	—	—	—	—	—	—	—	—	0000 0000 0000 0000
IPC0	0094	—	T1IP<2:0>			—	OC1IP<2:0>			—	IC1IP<2:0>			—	INT0IP<2:0>			0100 0100 0100 0100
IPC1	0096	—	T31P<2:0>			—	T2IP<2:0>			—	OC2IP<2:0>			—	IC2IP<2:0>			0100 0100 0100 0100
IPC2	0098	—	ADIP<2:0>			—	U1TXIP<2:0>			—	U1RXIP<2:0>			—	SPI1IP<2:0>			0100 0100 0100 0100
IPC3	009A	—	CNIP<2:0>			—	MI2CIP<2:0>			—	SI2CIP<2:0>			—	NVMIP<2:0>			0100 0100 0100 0100
IPC4	009C	—	—	—	—	—	—	—	—	—	—	—	—	—	INT1IP<2:0>			0000 0000 0000 0100
IPC5	009E	—	INT2IP<2:0>			—	—	—	—	—	—	—	—	—	—	—	—	0100 0000 0000 0000
IPC6	00A0	—	—	—	—	—	—	—	—	—	1	0	0	—	1	0	0	0000 0000 0100 0100
IPC7	00A2	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000 0000 0000 0000
IPC8	00A4	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000 0000 0000 0000
IPC9	00A6	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000 0000 0000 0000
IPC10	00A8	—	—	—	—	—	LVDIP<2:0>			—	—	—	—	—	—	—	—	0000 0100 0000 0000

**Legend:** u = uninitialized bit; — = unimplemented bit, read as '0'

**Note:** Refer to the "dsPIC30F Family Reference Manual" (DS70046) for descriptions of register bit fields.

NOTES:

TABLE 13-1: SPI1 REGISTER MAP

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
SPI1STAT	0220	SPIEN	—	SPISIDL	—	—	—	—	—	—	SPIROV	—	—	—	—	SPITBF	SPIRBF	0000 0000 0000 0000
SPI1CON	0222	—	FRMEN	SPIFSD	—	DISSDO	MODE16	SMP	CKE	SSEN	CKP	MSTEN	SPRE2	SPRE1	SPRE0	PPRE1	PPRE0	0000 0000 0000 0000
SPI1BUF	0224	Transmit and Receive Buffer																0000 0000 0000 0000

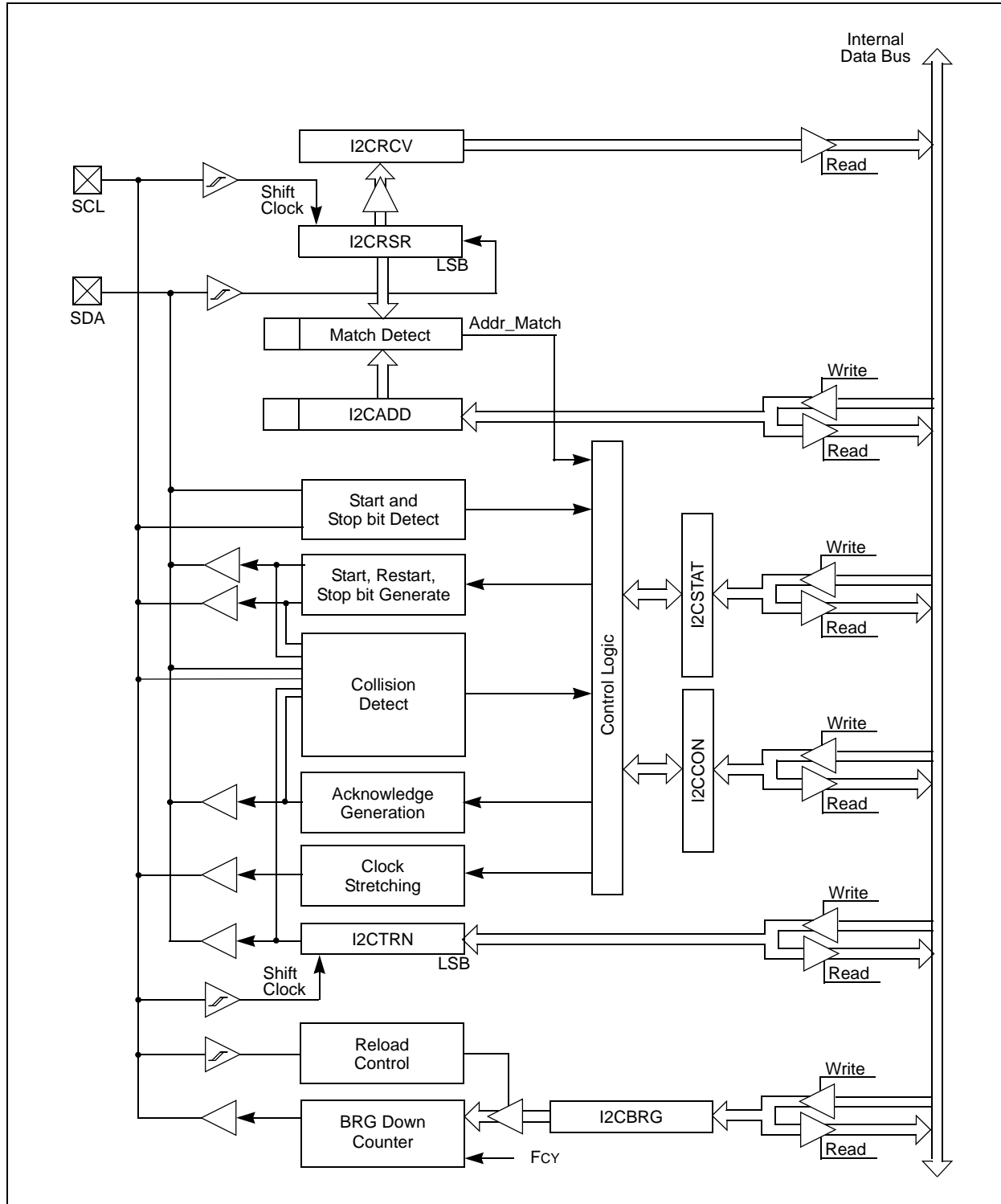
**Legend:** — = unimplemented bit, read as '0'

**Note:** Refer to the “dsPIC30F Family Reference Manual” (DS70046) for descriptions of register bit fields.



# dsPIC30F2011/2012/3012/3013

FIGURE 14-2: I<sup>2</sup>C™ BLOCK DIAGRAM



NOTES:

## 17.2.7 FAIL-SAFE CLOCK MONITOR

The Fail-Safe Clock Monitor (FSCM) allows the device to continue to operate even in the event of an oscillator failure. The FSCM function is enabled by appropriately programming the FCKSM Configuration bits (clock switch and monitor selection bits) in the FOSC Device Configuration register. If the FSCM function is enabled, the LPRC internal oscillator will run at all times (except during Sleep mode) and will not be subject to control by the SWDTEN bit.

In the event of an oscillator failure, the FSCM will generate a clock failure trap event and will switch the system clock over to the FRC oscillator. The user will then have the option to either attempt to restart the oscillator or execute a controlled shutdown. The user may decide to treat the trap as a warm Reset by simply loading the Reset address into the oscillator fail trap vector. In this event, the CF (Clock Fail) bit (OSCCON<3>) is also set whenever a clock failure is recognized.

In the event of a clock failure, the WDT is unaffected and continues to run on the LPRC clock.

If the oscillator has a very slow start-up time coming out of POR, BOR or Sleep, it is possible that the PWRT timer will expire before the oscillator has started. In such cases, the FSCM will be activated and the FSCM will initiate a clock failure trap, and the COSC<2:0> bits are loaded with FRC oscillator selection. This will effectively shut-off the original oscillator that was trying to start.

The user may detect this situation and restart the oscillator in the clock fail trap ISR.

Upon a clock failure detection, the FSCM module will initiate a clock switch to the FRC oscillator as follows:

1. The COSC bits (OSCCON<14:12>) are loaded with the FRC oscillator selection value.
2. CF bit is set (OSCCON<3>).
3. OSWEN control bit (OSCCON<0>) is cleared.

For the purpose of clock switching, the clock sources are sectioned into four groups:

- Primary (with or without PLL)
- Secondary
- Internal FRC
- Internal LPRC

The user can switch between these functional groups but cannot switch between options within a group. If the primary group is selected, then the choice within the group is always determined by the FPR<4:0> Configuration bits.

The OSCCON register holds the Control and Status bits related to clock switching.

- COSC<2:0>: Read-only bits always reflect the current oscillator group in effect.
- NOSC<2:0>: Control bits which are written to indicate the new oscillator group of choice.
  - On POR and BOR, COSC<2:0> and NOSC<2:0> are both loaded with the Configuration bit values FOS<2:0>.
- LOCK: The LOCK bit indicates a PLL lock.
- CF: Read-only bit indicating if a clock fail detect has occurred.
- OSWEN: Control bit changes from a '0' to a '1' when a clock transition sequence is initiated. Clearing the OSWEN control bit will abort a clock transition in progress (used for hang-up situations).

If Configuration bits FCKSM<1:0> = 1x, then the clock switching and Fail-Safe Clock monitoring functions are disabled. This is the default Configuration bit setting.

If clock switching is disabled, then the FOS<2:0> and FPR<4:0> bits directly control the oscillator selection and the COSC<2:0> bits do not control the clock selection. However, these bits will reflect the clock source selection.

**Note:** The application should not attempt to switch to a clock of frequency lower than 100 kHz when the Fail-Safe Clock Monitor is enabled. If such clock switching is performed, the device may generate an oscillator fail trap and switch to the Fast RC oscillator.

## 17.2.8 PROTECTION AGAINST ACCIDENTAL WRITES TO OSCCON

A write to the OSCCON register is intentionally made difficult because it controls clock switching and clock scaling.

To write to the OSCCON low byte, the following code sequence must be executed without any other instructions in between:

```
Byte Write 0x46 to OSCCON low
Byte Write 0x57 to OSCCON low
```

*Byte write is allowed for one instruction cycle. Write the desired value or use bit manipulation instruction.*

To write to the OSCCON high byte, the following instructions must be executed without any other instructions in between:

```
Byte Write 0x78 to OSCCON high
Byte Write 0x9A to OSCCON high
```

*Byte write is allowed for one instruction cycle. Write the desired value or use bit manipulation instruction.*

## 17.3 Reset

The dsPIC30F2011/2012/3012/3013 devices differentiate between various kinds of Reset:

- Power-on Reset (POR)
- $\overline{\text{MCLR}}$  Reset during normal operation
- $\overline{\text{MCLR}}$  Reset during Sleep
- Watchdog Timer (WDT) Reset (during normal operation)
- Programmable Brown-out Reset (BOR)
- RESET Instruction
- Reset caused by trap lockup (TRAPR)
- Reset caused by illegal opcode or by using an uninitialized W register as an address pointer (IOPUWR)

Different registers are affected in different ways by various Reset conditions. Most registers are not affected by a WDT wake-up since this is viewed as the resumption of normal operation. Status bits from the RCON register are set or cleared differently in different Reset situations, as indicated in Table 17-5. These bits are used in software to determine the nature of the Reset.

A block diagram of the On-Chip Reset Circuit is shown in Figure 17-2.

A  $\overline{\text{MCLR}}$  noise filter is provided in the  $\overline{\text{MCLR}}$  Reset path. The filter detects and ignores small pulses.

Internally generated Resets do not drive  $\overline{\text{MCLR}}$  pin low.

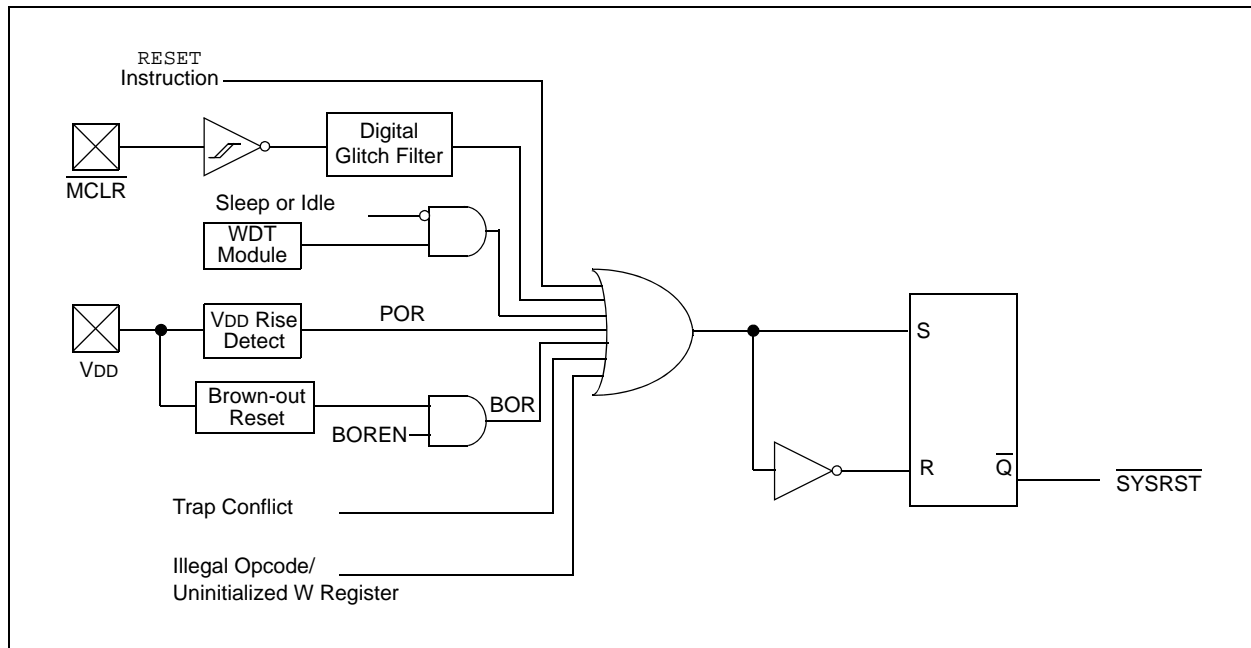
### 17.3.1 POR: POWER-ON RESET

A power-on event will generate an internal POR pulse when a VDD rise is detected. The Reset pulse will occur at the POR circuit threshold voltage (VPOR) which is nominally 1.85V. The device supply voltage characteristics must meet specified starting voltage and rise rate requirements. The POR pulse will reset a POR timer and place the device in the Reset state. The POR also selects the device clock source identified by the oscillator configuration fuses.

The POR circuit inserts a small delay, TPOR, which is nominally 10  $\mu\text{s}$  and ensures that the device bias circuits are stable. Furthermore, a user selected power-up time-out (TPWRT) is applied. The TPWRT parameter is based on device Configuration bits and can be 0 ms (no delay), 4 ms, 16 ms or 64 ms. The total delay is at device power-up, TPOR + TPWRT. When these delays have expired,  $\overline{\text{SYSRST}}$  will be negated on the next leading edge of the Q1 clock and the PC will jump to the Reset vector.

The timing for the  $\overline{\text{SYSRST}}$  signal is shown in Figure 17-3 through Figure 17-5.

**FIGURE 17-2: RESET SYSTEM BLOCK DIAGRAM**



**TABLE 17-7: SYSTEM INTEGRATION REGISTER MAP**

SFR Name	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
RCON	0740	TRAPR	IOPUWR	BGST	LVDEN	LVDL<3:0>				EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	(Note 1)
OSCCON	0742	—	COSC<2:0>			—	NOSC<2:0>			POST<1:0>		LOCK	—	CF	—	LPOSCEN	OSWEN	(Note 2)
OSCTUN	0744	—	—	—	—	—	—	—	—	—	—	—	—	TUN3	TUN2	TUN1	TUN0	(Note 2)
PMD1	0770	—	—	T3MD	T2MD	T1MD	—	—	—	I2CMD	U2MD <sup>(3)</sup>	U1MD	—	SPI1MD	—	—	ADCMD	0000 0000 0000 0000
PMD2	0772	—	—	—	—	—	—	IC2MD	IC1MD	—	—	—	—	—	—	OC2MD	OC1MD	0000 0000 0000 0000

**Legend:** — = unimplemented bit, read as '0'

**Note 1:** Reset state depends on type of reset.

**Note 2:** Reset state depends on Configuration bits.

**Note 3:** Only available on dsPIC30F3013 devices.

**TABLE 17-8: DEVICE CONFIGURATION REGISTER MAP**

Name	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
FOSC	F80000	FCKSM<1:0>		—	—	—	FOS<2:0>			—	—	—	FPR<4:0>				
FWDT	F80002	FWDTEN	—	—	—	—	—	—	—	—	—	FWPSA<1:0>		FWPSB<3:0>			
FBORPOR	F80004	MCLREN	—	—	—	—	PWMPIN <sup>(1)</sup>	HPOL <sup>(1)</sup>	LPOL <sup>(1)</sup>	BOREN	—	BORV<1:0>		—	—	FPWRT<1:0>	
FBS	F80006	—	—	Reserved <sup>(2)</sup>		—	—	—	Reserved <sup>(2)</sup>	—	—	—	—	Reserved <sup>(2)</sup>			
FSS	F80008	—	—	Reserved <sup>(2)</sup>		—	—	Reserved <sup>(2)</sup>		—	—	—	—	Reserved <sup>(2)</sup>			
FGS	F8000A	—	—	—	—	—	—	—	—	—	—	—	—	—	Reserved <sup>(3)</sup>	GCP	GWRP
FICD	F8000C	BKBUG	COE	—	—	—	—	—	—	—	—	—	—	—	—	ICS<1:0>	

**Legend:** — = unimplemented bit, read as '0'

**Note 1:** These bits are reserved (read as '1' and must be programmed as '1').

**Note 2:** Reserved bits read as '1' and must be programmed as '1'.

**Note 3:** The FGS<2> bit is a read-only copy of the GCP bit (FGS<1>).

## 18.0 INSTRUCTION SET SUMMARY

**Note:** This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the “dsPIC30F Family Reference Manual” (DS70046). For more information on the device instruction set and programming, refer to the “dsPIC30F Programmer’s Reference Manual” (DS70030).

The dsPIC30F instruction set adds many enhancements to the previous PIC® MCU instruction sets, while maintaining an easy migration from PIC MCU instruction sets.

Most instructions are a single program memory word (24 bits). Only three instructions require two program memory locations.

Each single-word instruction is a 24-bit word divided into an 8-bit opcode which specifies the instruction type, and one or more operands which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into five basic categories:

- Word or byte-oriented operations
- Bit-oriented operations
- Literal operations
- DSP operations
- Control operations

Table 18-1 shows the general symbols used in describing the instructions.

The dsPIC30F instruction set summary in Table 18-2 lists all the instructions, along with the status flags affected by each instruction.

Most word or byte-oriented W register instructions (including barrel shift instructions) have three operands:

- The first source operand which is typically a register ‘Wb’ without any address modifier
- The second source operand which is typically a register ‘Ws’ with or without an address modifier
- The destination of the result which is typically a register ‘Wd’ with or without an address modifier

However, word or byte-oriented file register instructions have two operands:

- The file register specified by the value ‘f’
- The destination, which could either be the file register ‘f’ or the W0 register, which is denoted as ‘WREG’

Most bit-oriented instructions (including simple rotate/shift instructions) have two operands:

- The W register (with or without an address modifier) or file register (specified by the value of ‘Ws’ or ‘f’)
- The bit in the W register or file register (specified by a literal value or indirectly by the contents of register ‘Wb’)

The literal instructions that involve data movement may use some of the following operands:

- A literal value to be loaded into a W register or file register (specified by the value of ‘k’)
- The W register or file register where the literal value is to be loaded (specified by ‘Wb’ or ‘f’)

However, literal instructions that involve arithmetic or logical operations use some of the following operands:

- The first source operand which is a register ‘Wb’ without any address modifier
- The second source operand which is a literal value
- The destination of the result (only if not the same as the first source operand) which is typically a register ‘Wd’ with or without an address modifier

The MAC class of DSP instructions may use some of the following operands:

- The accumulator (A or B) to be used (required operand)
- The W registers to be used as the two operands
- The X and Y address space prefetch operations
- The X and Y address space prefetch destinations
- The accumulator write-back destination

The other DSP instructions do not involve any multiplication, and may include:

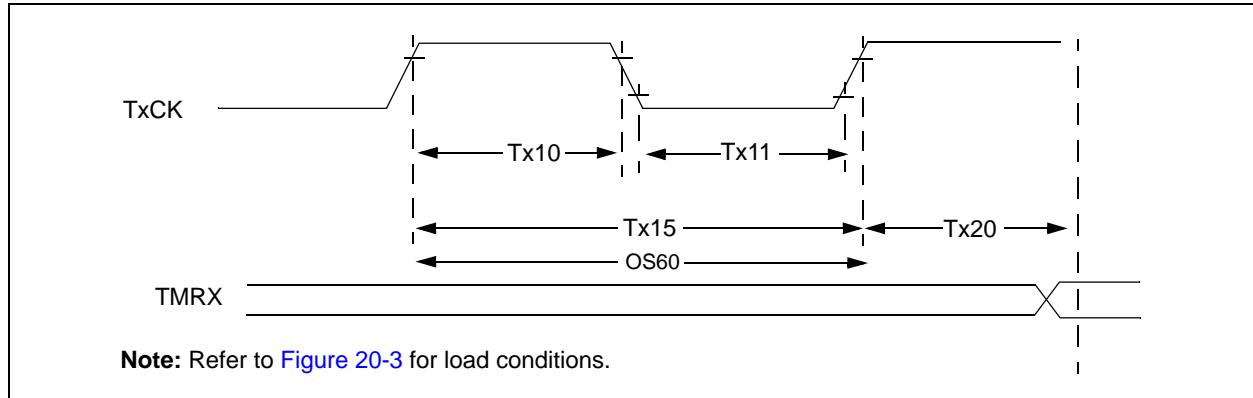
- The accumulator to be used (required)
- The source or destination operand (designated as Wso or Wdo, respectively) with or without an address modifier
- The amount of shift specified by a W register ‘Wn’ or a literal value

The control instructions may use some of the following operands:

- A program memory address
- The mode of the table read and table write instructions

# dsPIC30F2011/2012/3012/3013

**FIGURE 20-8: TYPE A, B AND C TIMER EXTERNAL CLOCK TIMING CHARACTERISTICS**



**TABLE 20-23: TYPE A TIMER (TIMER1) EXTERNAL CLOCK TIMING REQUIREMENTS**

AC CHARACTERISTICS				Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature    -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended				
Param No.	Symbol	Characteristic		Min	Typ	Max	Units	Conditions
TA10	T <sub>TXH</sub>	TxCK High Time	Synchronous, no prescaler	0.5 T <sub>CY</sub> + 20	—	—	ns	Must also meet parameter TA15
			Synchronous, with prescaler	10	—	—	ns	
			Asynchronous	10	—	—	ns	
TA11	T <sub>TXL</sub>	TxCK Low Time	Synchronous, no prescaler	0.5 T <sub>CY</sub> + 20	—	—	ns	Must also meet parameter TA15
			Synchronous, with prescaler	10	—	—	ns	
			Asynchronous	10	—	—	ns	
TA15	T <sub>TXP</sub>	TxCK Input Period	Synchronous, no prescaler	T <sub>CY</sub> + 10	—	—	ns	N = prescale value (1, 8, 64, 256)
			Synchronous, with prescaler	Greater of: 20 ns or (T <sub>CY</sub> + 40)/N	—	—	—	
			Asynchronous	20	—	—	ns	
OS60	F <sub>t1</sub>	SOSC1/T1CK oscillator input frequency range (oscillator enabled by setting bit TCS (T1CON, bit 1))		DC	—	50	kHz	
TA20	T <sub>CKEXTMRL</sub>	Delay from External TxCK Clock Edge to Timer Increment		0.5 T <sub>CY</sub>	—	1.5 T <sub>CY</sub>	—	

**Note:** Timer1 is a Type A.

# dsPIC30F2011/2012/3012/3013

**TABLE 20-32: SPI MODULE SLAVE MODE (CKE = 1) TIMING REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Symbol	Characteristic <sup>(1)</sup>	Min	Typ <sup>(2)</sup>	Max	Units	Conditions
SP70	TscL	SCKx Input Low Time	30	—	—	ns	—
SP71	TscH	SCKx Input High Time	30	—	—	ns	—
SP72	TscF	SCKx Input Fall Time <sup>(3)</sup>	—	10	25	ns	—
SP73	TscR	SCKx Input Rise Time <sup>(3)</sup>	—	10	25	ns	—
SP30	TdoF	SDOx Data Output Fall Time <sup>(3)</sup>	—	—	—	ns	See parameter DO32
SP31	TdoR	SDOx Data Output Rise Time <sup>(3)</sup>	—	—	—	ns	See parameter DO31
SP35	Tsch2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	—	—	30	ns	—
SP40	TdiV2sch, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	20	—	—	ns	—
SP41	Tsch2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	20	—	—	ns	—
SP50	TssL2sch, TssL2scL	$\overline{SS}x\downarrow$ to SCKx $\downarrow$ or SCKx $\uparrow$ input	120	—	—	ns	—
SP51	TssH2doZ	$\overline{SS}x\uparrow$ to SDOx Output high impedance <sup>(4)</sup>	10	—	50	ns	—
SP52	Tsch2ssH TscL2ssH	$\overline{SS}x\uparrow$ after SCKx Edge	1.5 Tcy + 40	—	—	ns	—
SP60	TssL2doV	SDOx Data Output Valid after SCKx Edge	—	—	50	ns	—

**Note 1:** These parameters are characterized but not tested in manufacturing.

**2:** Data in “Typ” column is at 5V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

**3:** The minimum clock period for SCK is 100 ns. Therefore, the clock generated in Master mode must not violate this specification.

**4:** Assumes 50 pF load on all SPI pins.



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**TABLE 20-37: 12-BIT A/D CONVERSION TIMING REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 2.7V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Symbol	Characteristic	Min.	Typ	Max.	Units	Conditions
<b>Clock Parameters</b>							
AD50	TAD	A/D Clock Period	334	—	—	ns	VDD = 3-5.5V (Note 1)
AD51	tRC	A/D Internal RC Oscillator Period	1.2	1.5	1.8	μs	
<b>Conversion Rate</b>							
AD55	tCONV	Conversion Time	—	14 TAD	—	ns	
AD56a	FCNV	Throughput Rate	—	200	—	ksps	VDD = VREF = 5V, Industrial temperature
AD56b	FCNV	Throughput Rate	—	100	—	ksps	VDD = VREF = 5V, Extended temperature
AD57	TSAMP	Sampling Time	1 TAD	—	—	ns	VDD = 3-5.5V source resistance Rs = 0-2.5 kΩ
<b>Timing Parameters</b>							
AD60	tPCS	Conversion Start from Sample Trigger	—	1 TAD	—	ns	
AD61	tPSS	Sample Start from Setting Sample (SAMP) Bit	0.5 TAD	—	1.5 TAD	ns	
AD62	tCSS	Conversion Completion to Sample Start (ASAM = 1)	—	0.5 TAD	—	ns	
AD63	tDPU <sup>(2)</sup>	Time to Stabilize Analog Stage from A/D Off to A/D On	—	—	20	μs	

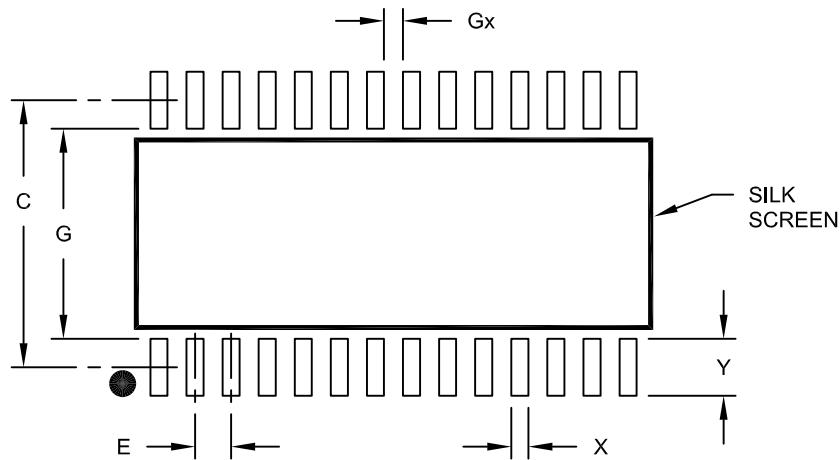
**Note 1:** Because the sample caps will eventually lose charge, clock rates below 10 kHz can affect linearity performance, especially at elevated temperatures.

**2:** tDPU is the time required for the ADC module to stabilize when it is turned on (ADCON1<ADON> = 1). During this time the ADC result is indeterminate.

# dsPIC30F2011/2012/3012/3013

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



## RECOMMENDED LAND PATTERN

		Units	MILLIMETERS		
		Dimension Limits	MIN	NOM	MAX
Contact Pitch	E			1.27 BSC	
Contact Pad Spacing	C			9.40	
Contact Pad Width (X28)	X				0.60
Contact Pad Length (X28)	Y				2.00
Distance Between Pads	Gx		0.67		
Distance Between Pads	G		7.40		

### Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

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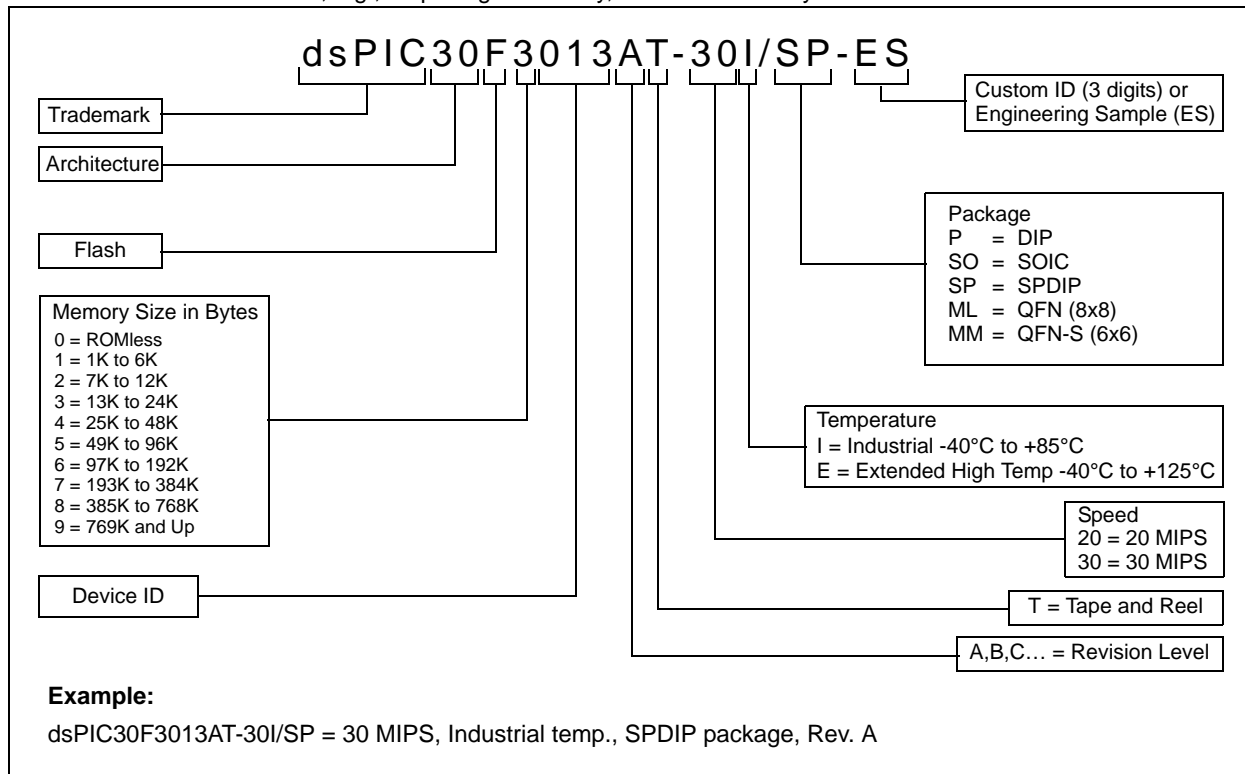
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